Ideal for space critical applications, the LM4431

voltage reference is available in the sub-miniature

(3 mm x 1.3 mm) SOT-23 surface-mount package.

The LM4431's advanced design eliminates the need for an external stabilizing capacitor while ensuring

stability with any capacitive load, thus making the LM4431 easy to use. The operating current range is

The LM4431 utilizes fuse and zener-zap reverse

breakdown voltage trim during wafer sort to ensure

that the parts have an accuracy of better than ±2.0% at 25°C. Bandgap reference temperature drift

curvature correction and low dynamic impedance

ensure stable reverse breakdown voltage accuracy

over a wide range of operating temperatures and



# LM4431 Micropower Shunt Voltage Reference

Check for Samples: LM4431

DESCRIPTION

 $100 \mu A$  to 15 mA.

currents.

### **FEATURES**

- **Small Package: SOT-23**
- **No Output Capacitor Required**
- **Tolerates Capacitive Loads**
- Fixed Reverse Breakdown Voltage of 2.50V

#### **APPLICATIONS**

- Portable, Battery-Powered Equipment
- **Data Acquisition Systems**
- Instrumentation
- **Process Control**
- **Energy Management**
- **Product Testing**
- **Power Supplies**

#### **KEY SPECIFICATIONS**

- Output Voltage Tolerance: 25°C: ±2.0% (Max)
- Low Output Noise (10 Hz to 10 kHz): 35 μV<sub>rms</sub>
- Wide Operating Current Range: 100 µA to 15
- Commercial Temperature Range: 0 to +70 °C
- Low Temperature Coefficient: 30 ppm/°C (Typ)

#### **Connection Diagram**

#### **Top View**



<sup>\*</sup> This pin must be left floating or connected to pin 2.

#### Figure 1. SOT-23 Package See Package Number DBZ0003A



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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# **Absolute Maximum Ratings**(1)(2)

Reverse Current	20 mA		
Forward Current	10 mA		
Power Dissipation $(T_A = 25^{\circ}C)^{(3)}$	306 mW		
Storage Temperature			-65°C to +150°C
Lood Townsonstons	DD70000A Doctions	Vapor phase (60 seconds)	+215°C
Lead Temperature	DBZ0003A Package	Infrared (15 seconds)	+220°C
ECD Company the list of		Human Body Model (4)	2 kV
ESD Susceptibility		Machine Model (4)	200V

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The specified specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) The maximum power dissipation must be derated at elevated temperatures and is dictated by T<sub>Jmax</sub> (maximum junction temperature), θ<sub>JA</sub> (junction to ambient thermal resistance), and T<sub>A</sub> (ambient temperature). The maximum allowable power dissipation at any temperature is PD<sub>max</sub> = (T<sub>Jmax</sub> ¬ T<sub>A</sub>)/θ<sub>JA</sub> or the number given in the Absolute Maximum Ratings, whichever is lower. For the LM4431, T<sub>Jmax</sub> = 125°C, and the typical thermal resistance (θ<sub>JA</sub>), when board mounted, is 326°C/W for the SOT-23 package.
- (4) The human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. The machine model is a 200 pF capacitor discharged directly into each pin.

# Operating Ratings<sup>(1)(2)</sup>

Temperature Range $(T_{min} \le T_A \le T_{max})$	0°C ≤ T <sub>A</sub> ≤ +70°C	
Reverse Current	LM4431-2.5	100 µA to 15 mA

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The specified specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) The maximum power dissipation must be derated at elevated temperatures and is dictated by T<sub>Jmax</sub> (maximum junction temperature), θ<sub>JA</sub> (junction to ambient thermal resistance), and T<sub>A</sub> (ambient temperature). The maximum allowable power dissipation at any temperature is PD<sub>max</sub> = (T<sub>Jmax</sub> T<sub>A</sub>)/θ<sub>JA</sub> or the number given in the Absolute Maximum Ratings, whichever is lower. For the LM4431, T<sub>Jmax</sub> = 125°C, and the typical thermal resistance (θ<sub>JA</sub>), when board mounted, is 326°C/W for the SOT-23 package.

Product Folder Links: LM4431



## LM4431-2.5 Electrical Characteristics

Boldface limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_J = 25$ °C.

Symbol	Parameter	Conditions	Typical <sup>(1)</sup>	LM4431M3 Limits <sup>(2)</sup>	Units (Limit)
V <sub>R</sub>	Reverse Breakdown Voltage	I <sub>R</sub> = 100 μA	2.500		V
	Reverse Breakdown VoltageTolerance	I <sub>R</sub> = 100 μA		±50	mV (max)
I <sub>RMIN</sub>	Minimum On anatin a Commant		45		μA
	Minimum Operating Current			100	μA (max)
$\Delta V_R/\Delta T$		I <sub>R</sub> = 10 mA	±30		ppm/°C
	Average Reverse Breakdown Voltage Temperature Coefficient	I <sub>R</sub> = 1 mA	±30		ppm/°C
	remperature document	I <sub>R</sub> = 100 μA	±30		ppm/°C
$\Delta V_R/\Delta I_R$		$I_{RMIN} \le I_R \le 1 \text{ mA}$	0.4		mV
				1.0	mV (max)
	Reverse Breakdown Voltage Change with Operating Current Change			1.2	mV (max)
		1 mA ≤ I <sub>R</sub> ≤ 15 mA	2.5		mV
				8.0	mV (max)
				25	mV (max)
Z <sub>R</sub>	Reverse Dynamic Impedance	I <sub>R</sub> = 1 mA, f = 120 Hz, I <sub>AC</sub> = 0.1 I <sub>R</sub>	1.0		Ω
e <sub>N</sub>	Wideband Noise	$I_R = 100 \mu A$ , 10 Hz \le f \le 10 kHz	35		$\mu V_{rms}$
$\Delta V_R$		t = 1000 hrs			
	Reverse Breakdown Voltage Long Term Stability	T = 25°C ±0.1°C	120		ppm
	Clabinty	I <sub>R</sub> = 100 μA			

Product Folder Links: LM4431

 <sup>(1)</sup> Typicals are at T<sub>J</sub> = 25°C and represent most likely parametric norm.
 (2) Limits are 100% production tested at 25°C. Limits over temperature are ensured through correlation using Statistical Quality Control (SQC) methods. The limits are used to calculate AOQL.



# **Typical Performance Characteristics**

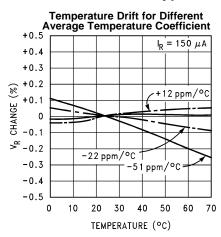
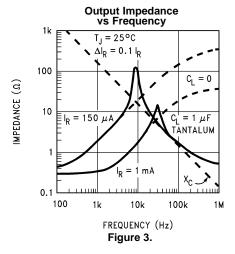
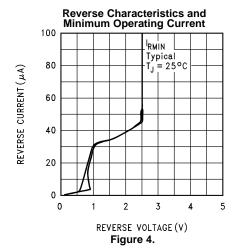
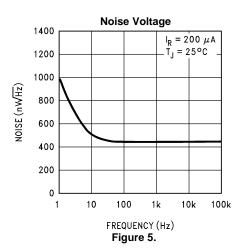


Figure 2.







# **Start-Up Characteristics**

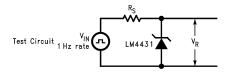


Figure 6. Test Circuit

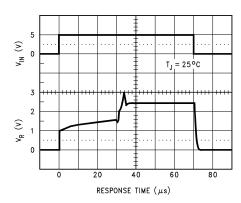
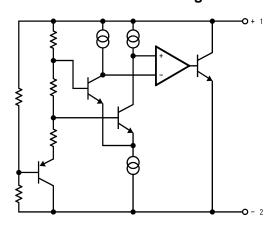


Figure 7. LM4431-2.5,  $R_S = 30k$ 



# **Functional Block Diagram**



#### APPLICATIONS INFORMATION

The LM4431 is a micro-power curvature-corrected 2.5V bandgap shunt voltage reference. For space critical applications, the LM4431 is available in the sub-miniature SOT-23 surface-mount package. The LM4431 has been designed for stable operation without the need of an external capacitor connected between the "+" pin and the "-" pin. If, however, a bypass capacitor is used, the LM4431 remains stable. The operating current range is  $100 \, \mu A$  to  $15 \, m A$ .

The LM4431's SOT-23 package has a parasitic Schottky diode between pin 2 (–) and pin 3 (Die attach interface contact). Therefore, pin 3 of the SOT-23 package must be left floating or connected to pin 2.

In a conventional shunt regulator application (Figure 8), an external series resistor ( $R_S$ ) is connected between the supply voltage and the LM4431.  $R_S$  determines the current that flows through the load ( $I_L$ ) and the LM4431 ( $I_Q$ ). Since load current and supply voltage may vary,  $R_S$  should be small enough to supply at least the minimum acceptable  $I_Q$  to the LM4431 even when the supply voltage is at its minimum and the load current is at its maximum value. When the supply voltage is at its maximum and  $I_L$  is at its minimum,  $R_S$  should be large enough so that the current flowing through the LM4431 is less than 15 mA.

 $R_S$  is determined by the supply voltage,  $(V_S)$ , the load and operating current,  $(I_L$  and  $I_Q)$ , and the LM4431's reverse breakdown voltage,  $V_R$ .

$$R_{S} = \frac{V_{S} - V_{R}}{I_{L} + I_{Q}} \tag{1}$$

### **Typical Applications**

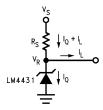


Figure 8. Shunt Regulator

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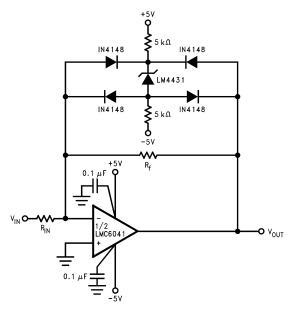


Figure 9. Bounded amplifier reduces saturation-induced delays and can prevent succeeding stage damage.

Nominal clamping voltage is ±3.9V (LM4431's reverse breakdown voltage +2 diode V<sub>F</sub>).

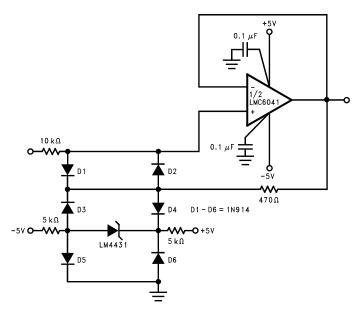
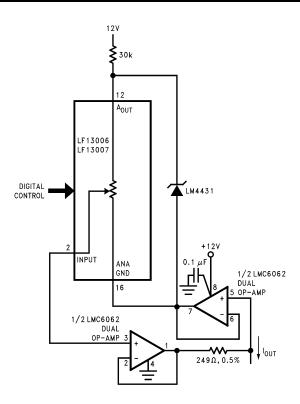


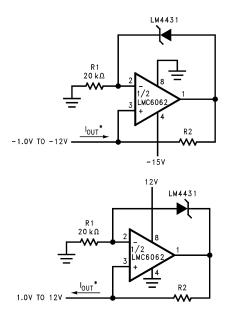
Figure 10. Protecting Op Amp input. The bounding voltage is  $\pm 4V$  with the LM4431 (LM4431's reverse breakdown voltage + 3 diode  $V_F$ ).





$$I_{OUT} = \frac{2.5V}{249\Omega} \left[ \frac{1}{\text{gain set #}} \right]$$

Figure 11. Programmable Current Source



 $*I_{OUT} = \frac{2.5V}{R2}$ 

Figure 12. Precision 1 µA to 1 mA Current Sources



# **REVISION HISTORY**

Cł	hanges from Revision B (April 2013) to Revision C	Page
•	Changed layout of National Data Sheet to TI format	7

www.ti.com 11-Nov-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
LM4431M3-2.5/NOPB	Active	Production	SOT-23 (DBZ)   3	3000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	S2E
LM4431M3-2.5/NOPB.A	Active	Production	SOT-23 (DBZ)   3	3000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	S2E
LM4431M3-2.5/NOPB.B	Active	Production	SOT-23 (DBZ)   3	3000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	S2E
LM4431M3X-2.5/NOPB	Active	Production	SOT-23 (DBZ)   3	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	S2E
LM4431M3X-2.5/NOPB.A	Active	Production	SOT-23 (DBZ)   3	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	S2E
LM4431M3X-2.5/NOPB.B	Active	Production	SOT-23 (DBZ)   3	3000   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	0 to 70	S2E

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



# **PACKAGE OPTION ADDENDUM**

www.ti.com 11-Nov-2025

**PACKAGE MATERIALS INFORMATION** 

www.ti.com 20-Sep-2025

## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM4431M3-2.5/NOPB	SOT-23	DBZ	3	3000	178.0	8.4	3.3	2.9	1.22	4.0	8.0	Q3
LM4431M3-2.5/NOPB	SOT-23	DBZ	3	3000	180.0	8.4	3.2	2.85	1.3	4.0	8.0	Q3
LM4431M3X-2.5/NOPB	SOT-23	DBZ	3	3000	178.0	8.4	3.3	2.9	1.22	4.0	8.0	Q3
LM4431M3X-2.5/NOPB	SOT-23	DBZ	3	3000	180.0	8.4	3.2	2.85	1.3	4.0	8.0	Q3



www.ti.com 20-Sep-2025



### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM4431M3-2.5/NOPB	SOT-23	DBZ	3	3000	208.0	191.0	35.0
LM4431M3-2.5/NOPB	SOT-23	DBZ	3	3000	210.0	185.0	35.0
LM4431M3X-2.5/NOPB	SOT-23	DBZ	3	3000	208.0	191.0	35.0
LM4431M3X-2.5/NOPB	SOT-23	DBZ	3	3000	210.0	185.0	35.0



SMALL OUTLINE TRANSISTOR



### NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
   This drawing is subject to change without notice.
   Reference JEDEC registration TO-236, except minimum foot length.

- 4. Support pin may differ or may not be present.
- 5. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



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